



3
YEARS
WARRANTY

ROHS
COMPLIANT

REACH
COMPLIANT



Automation



Datacom



IPC



Industry



Measurement



Telecom



Automobile



Boat



Charger



Medical



PV



Railway



1600
VDC
Isolation
Voltage

2 : 1
Input
Range

NO
Min. Load
Required

OCP

SCP

PART NUMBER STRUCTURE

FKC03 -	48	S	05	-	M1	SMD
Series Name	Input Voltage (VDC)	Output Quantity	Output Voltage (VDC)		Operating Temp. Options	Mounting Type Options
	12:9~18 24:18~36 48:36~75	S:Single	33:3.3 05:5 12:12 15:15		□: Standard -25~+100°C With derating M1: -40~+105°C +85°C without derating M2: -40~+100°C With derating	□: DIP type SMD: SMD type
		D: Dual	05:±5 12:±12 15:±15			

TECHNICAL SPECIFICATION All specifications are typical at nominal input, full load and 25°C unless otherwise noted

Model Number	Input Range	Output Voltage	Output Current @Full Load	Input Current @No Load	Efficiency	Maximum Capacitor Load
	VDC	VDC	mA	mA	%	μF
FKC03-12S33	9 ~ 18	3.3	500	10	75	2200
FKC03-12S05	9 ~ 18	5	500	10	76	1000
FKC03-12S12	9 ~ 18	12	250	10	80	220
FKC03-12S15	9 ~ 18	15	200	15	81	150
FKC03-12D05	9 ~ 18	±5	±250	15	78	±470
FKC03-12D12	9 ~ 18	±12	±125	15	80	±100
FKC03-12D15	9 ~ 18	±15	±100	20	82	±68
FKC03-24S33	18 ~ 36	3.3	500	10	72	2200
FKC03-24S05	18 ~ 36	5	500	10	74	1000
FKC03-24S12	18 ~ 36	12	250	15	78	220
FKC03-24S15	18 ~ 36	15	200	15	78	150
FKC03-24D05	18 ~ 36	±5	±250	15	74	±470
FKC03-24D12	18 ~ 36	±12	±125	20	77	±100
FKC03-24D15	18 ~ 36	±15	±100	20	77	±68
FKC03-48S33	36 ~ 75	3.3	500	5	74	2200
FKC03-48S05	36 ~ 75	5	500	10	74	1000
FKC03-48S12	36 ~ 75	12	250	10	79	220
FKC03-48S15	36 ~ 75	15	200	10	78	150
FKC03-48D05	36 ~ 75	±5	±250	10	73	±470
FKC03-48D12	36 ~ 75	±12	±125	10	79	±100
FKC03-48D15	36 ~ 75	±15	±100	10	77	±68

INPUT SPECIFICATIONS

Parameter	Conditions	Min.	Typ.	Max.	Unit
Operating input voltage range	12Vin(nom)	9	12	18	VDC
	24Vin(nom)	18	24	36	
	48Vin(nom)	36	48	75	
Start up time	Constant resistive load			350	ms
Input surge voltage	100 ms, max.	12Vin(nom)		36	VDC
		24Vin(nom)		50	
		48Vin(nom)		100	
Input filter				Pi type	

OUTPUT SPECIFICATIONS

Parameter	Conditions	Min.	Typ.	Max.	Unit
Voltage accuracy		-1.0		+1.0	%
Line regulation	Low Line to High Line at Full Load	-0.2		+0.2	%
Load regulation	No Load to Full Load	Single		+0.2	%
		Dual	-1.0	+1.0	
Cross regulation	Asymmetrical load 25%/100% FL	-5.0		+5.0	%
Ripple and noise	20MHz bandwidth		50		mVp-p
Temperature coefficient		-0.02		+0.02	%/°C
Transient response recovery time	25% load step change		200		μs
Over load protection	% of Iout rated		180		%
Short circuit protection					Continuous, automatics recovery

GENERAL SPECIFICATIONS

Parameter	Conditions			Min.	Typ.	Max.	Unit
Isolation voltage	1 minute	DIP type	Input to Output	1600			VDC
			Input (Output) to Case	1600			
	SMD type	Input to Output	1600				
		Input (Output) to Case	1000				
Isolation resistance	500VDC			1			GΩ
Isolation capacitance						300	pF
Switching frequency				270	300	330	kHz
Safety approvals	IEC /EN /UL 62368-1					UL:E193009 CB:UL(Demko)	
Case material						Nickel-coated copper	
Base material						Non-conductive black plastic	
Potting material						Epoxy (UL94 V-0)	
Weight						18g (0.62oz)	
MTBF	MIL-HDBK-217F					7.289 x 10 ⁶ hrs	

ENVIRONMENTAL SPECIFICATIONS

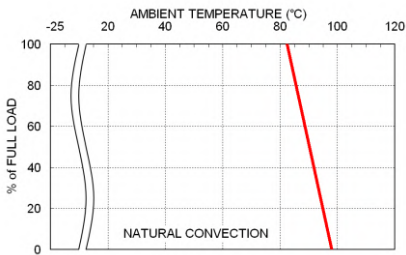
Parameter	Conditions			Min.	Typ.	Max.	Unit
Operating ambient temperature	Standard	With derating		-25		+100	°C
	M1 Version	+85°C without derating		-40		+105	
	M2 Version	With derating		-40		+100	
	*It's higher efficiency for M1 version. Therefore, it can be operated in a more extensive temperature range than standard and M2 version.						
Maximum case temperature	M1 Version					105	°C
	Others					100	
Storage temperature range				-55		+125	°C
Thermal impedance	Natural convection				20		°C/W
Thermal shock							MIL-STD-810F
Vibration							MIL-STD-810F
Relative humidity							5% to 95% RH
Lead-free reflow solder process	Only for SMD type					The time above 217°C 30~60sec. Peak temperature 245°C max. Time above 240°C 10sec. max.	

EMC SPECIFICATIONS

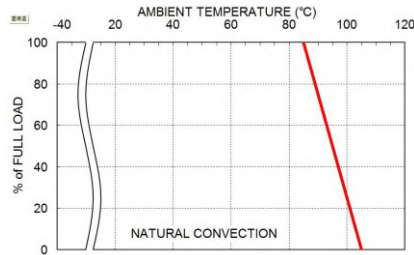
Parameter	Conditions		Level
EMI	EN55032	With external components	Class A · Class B
EMS	EN55035		
ESD	EN61000-4-2	Air ± 8kV and Contact ± 6kV	Perf. Criteria A
Radiated immunity	EN61000-4-3	10 V/m	Perf. Criteria A
Fast transient	EN61000-4-4	± 2kV	Perf. Criteria A
		With an external input filter capacitor (Nippon chemi-con KY series, 220μF/100V)	
Surge	EN61000-4-5	± 1kV	Perf. Criteria A
		With an external input filter capacitor (Nippon chemi-con KY series, 220μF/100V)	
Conducted immunity	EN61000-4-6	10 Vr.m.s	Perf. Criteria A
Power frequency magnetic field	EN61000-4-8	100A/m continuous; 1000A/m 1 second	Perf. Criteria A

CAUTION: This power module is not internally fused. An input line fuse must always be used.

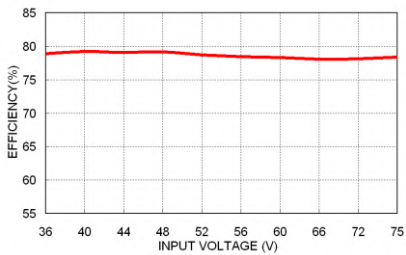
CHARACTERISTIC CURVE



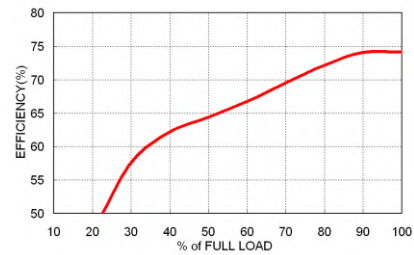
FKC03-48S05 Derating Curve



FKC03-48S05-M1 Derating Curve



FKC03-48S05 Efficiency vs. Input Voltage



FKC03-48S05 Efficiency vs. Output Load

FUSE CONSIDERATION

This power module is not internally fused. An input line fuse must always be used.

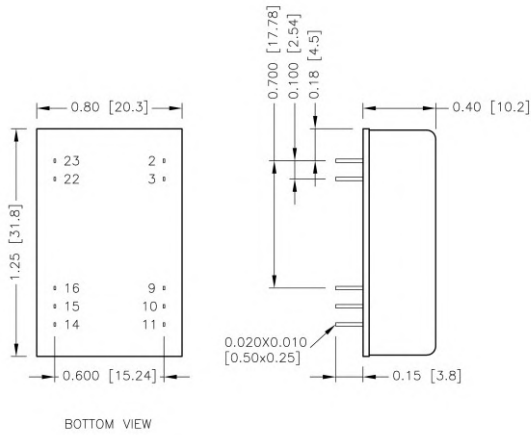
This encapsulated power module can be used in a wide variety of applications, ranging from simple stand-alone operation to an integrated part of sophisticated power architecture.

To maximum flexibility, internal fusing is not included; however, to achieve maximum safety and system protection, always use an input line fuse.

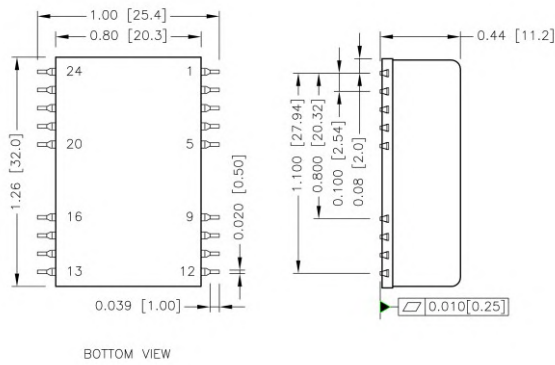
The input line fuse suggest as below :

Model	Fuse Rating (A)	Fuse Type
FKC03-12S□□、FKC03-12D□□	0.8	Slow-Blow
FKC03-24S□□、FKC03-24D□□	0.5	Slow-Blow
FKC03-48S□□、FKC03-48D□□	0.315	Slow-Blow

The table based on the information provided in this data sheet on inrush energy and maximum DC input current at low Vin.

MECHANICAL DRAWING
DIP type

PIN CONNECTION

PIN	SINGLE	DUAL	PIN	SINGLE	DUAL
2	-Vin	-Vin	23	+Vin	+Vin
3	-Vin	-Vin	22	+Vin	+Vin
9	NC	Common	16	-Vout	Common
10	NC	NC	15	NC	NC
11	NC	-Vout	14	+Vout	+Vout

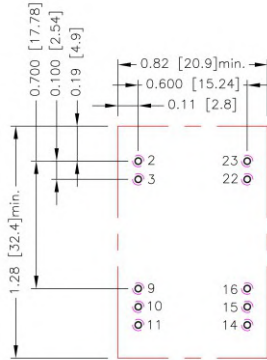
SMD type

PIN CONNECTION

PIN	SINGLE	DUAL	PIN	SINGLE	DUAL
2	-Vin	-Vin	23	+Vin	+Vin
3	-Vin	-Vin	22	+Vin	+Vin
9	NC	Common	16	-Vout	Common
10	NC	NC	15	NC	NC
11	NC	-Vout	14	+Vout	+Vout
Others	NC	NC			

- All dimensions in inch [mm]
- Tolerance :x.xx±0.02 [x.x±0.5]
x.xxx±0.01 [x.xx±0.25]
- Pin dimension tolerance ±0.004[0.10]

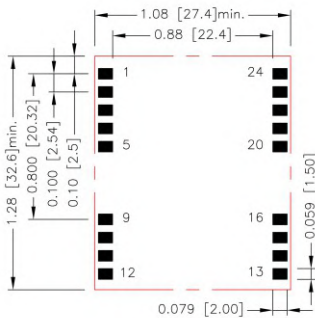
RECOMMENDED PAD LAYOUT

DIP type



All dimensions in inch[mm]
 Pad size(lead free recommended)
 Through hole 2.3.9.10.11.14.15.16.22.23: $\Phi 0.031$ [0.80]
 Top view pad 2.3.9.10.11.14.15.16.22.23: $\Phi 0.039$ [1.00]
 Bottom view pad 2.3.9.10.11.14.15.16.22.23: $\Phi 0.063$ [1.60]

SMD type

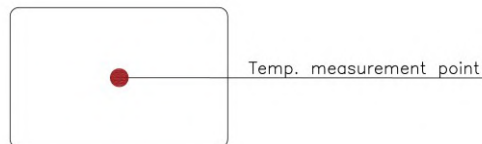


All dimensions in inch[mm]
 Pad size(lead free recommended)
 Top view pad:0.079x0.059[2.00x1.50]

THERMAL CONSIDERATIONS

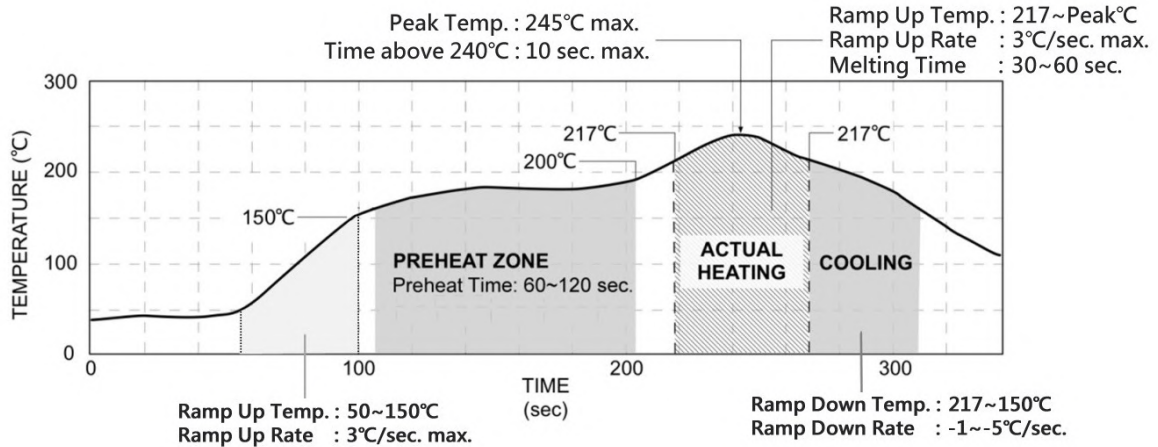
The power module operates in a variety of thermal environments. However, sufficient cooling should be provided to help ensure reliable operation of the unit. Heat is removed by conduction, convection, and radiation to the surrounding environment. Proper cooling can be verified by measuring the point as the figure below. The case temperature (T_c) should be measured at the position as the figure below. The temperature at this location should not exceed "Maximum case temperature". When operating, adequate cooling must be provided to maintain the test point temperature at or below "Maximum case temperature". You can limit this temperature to a lower value for extremely high reliability.

- Thermal test condition with vertical direction by natural convection (20LFM).



TOP VIEW

LEAD FREE REFLOW PROFILE For SMD Type



*The curves define the maximum peak reflow temperature permissible measured on pin1 or Vin pin.